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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Chuen Khiang WANG et al.

Appl. No. : Not Yet Assigned (U.S. National Stage of PCT/SG2005/000067)

I.A. Filed : March 3, 2005

For : MULTIPLE STACKED DIE WINDOW CSP PACKAGE AND METHOD
OF MANUFACTURE

PRELIMINARY AMENDMENT

Commissioner for Patents
U.S. Patent and Trademark Office
Customer Service Window, Mail Stop
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

Prior to an examination of the instant Application, Applicants respectfully request
that the claims be amended as shown below.

Amendments to the Claims begin on page 2 of this paper.
Remarks begin on page 8 of this paper.